

**FOTOFET™**  
SILICON EPITAXIAL JUNCTION  
N-CHANNEL FIELD EFFECT TRANSISTOR

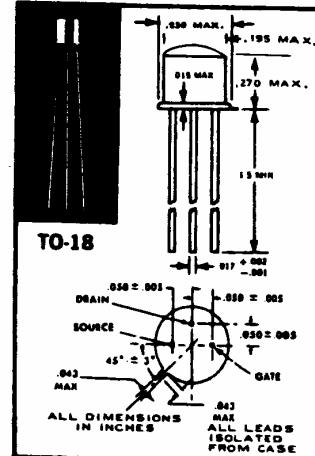
FF412

GEOMETRY 446

- HIGH SENSITIVITY
- LOW DARK CURRENT
- FAST RESPONSE
- LOW  $R_{ON}$

ELECTRICAL DATA ABSOLUTE MAXIMUM RATING

Drain to Source Voltage	BV <sub>DSD</sub>	30 Volts
Drain to Gate Voltage	BV <sub>DG0</sub>	30 Volts
Gate to Source Voltage	BV <sub>GSD</sub>	-15 Volts
D.C. Forward Gate Current	I <sub>GF</sub>	50 mA
Junction Temp (operating and storage)	T <sub>J</sub>	-65°C to +200°C
Power Dissipation (free air)	P <sub>D</sub>	300mW
Lead Temp (@1/16" ± 1/32" from case)	T <sub>L</sub>	240°C for 10 sec.
Derating Factor From 200°C	D <sub>F</sub>	1.7mW/°C



ACTIVE AREA 0.0009 SQ. CM.  
AT DIE SURFACE SENSITIVITY  $\sim 3\mu A/\mu W$

ELECTRICAL CHARACTERISTICS:  $T_A = 25^\circ C$

PARAMETER	SYMBOL	CONDITION	FF412			Units
			Min.	Typ.	Max.	
Gate Sensitivity <sup>5</sup>	S <sub>G</sub>	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0, $\lambda = .9$ microns	5.0	7.5	—	$\mu A/mW/cm^2$
Gate Current (Light) <sup>1</sup>	$\lambda I_G$	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V	8.0	12.0	—	nA/fC
Drain Sensitivity <sup>6</sup>	S <sub>D</sub>	V <sub>DS</sub> = 15V, I <sub>D</sub> = 5mA, R <sub>G</sub> = 1M $\Omega$	—	90	—	$mA/mW/cm^2$
Drain Current (Light) <sup>1</sup>	$\lambda I_D$	V <sub>DS</sub> = 15V, I <sub>D</sub> = 5mA, R <sub>G</sub> = 1M $\Omega$	—	144	—	$\mu A/fC$
Zero Gate Voltage Drain Current <sup>4</sup>	I <sub>DSS</sub>	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0	5.0	35	—	mA
Transconductance	g <sub>m</sub>	V <sub>DS</sub> = 15V, I <sub>D</sub> = 5mA, f = 1kHz	8,000	15,000	25,000	$\mu mho$
Rise Time <sup>2</sup>	T <sub>R</sub>	V <sub>DS</sub> = 15V, R <sub>L</sub> = 1K, R <sub>G</sub> = 1K	—	25	—	nsec
Fall Time <sup>3</sup>	T <sub>F</sub>	V <sub>DS</sub> = 15V, R <sub>L</sub> = 1K, R <sub>G</sub> = 1K	—	40	—	nsec
Pinch-Off Voltage	V <sub>PO</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> = 10.0 nA	1.0	3.0	5.0	Volts
Gate to Source Cap.	C <sub>GS</sub>	V <sub>GS</sub> = -10V, f = 140 kHz	—	—	6.5	pfd
Gate to Drain Cap.	C <sub>GD</sub>	V <sub>GD</sub> = -10V, f = 140 kHz	—	—	6.5	pfd
Gate Leakage Current (Dark)	I <sub>GS</sub>	V <sub>GS</sub> = -5V, V <sub>DS</sub> = 25	—	0.05	1.0	nA
ON Resistance	R <sub>DS</sub>	V <sub>DS</sub> = 0.1V, V <sub>GS</sub> = 0	—	50	100	Ohms

<sup>1</sup> Tungsten Lamp 2800° K Color Temp.

<sup>2</sup> GaAs Diode Source.

<sup>3</sup> Directly Proportional to R<sub>G</sub>

<sup>4</sup> Pulse Measurement 1% Duty Cycle, 10MS Max.

<sup>5</sup> Gate Current per unit Radiant Power Density at Lens Surface

<sup>6</sup> Drain Current per unit Radiant Power Density ( $\lambda = 0.9$  microns)

**CRYSTALONCS**  
2805 Veterans Highway  
Suite 14  
Ronkonkoma, N.Y. 11779